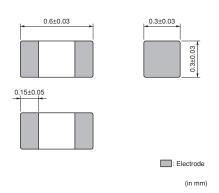
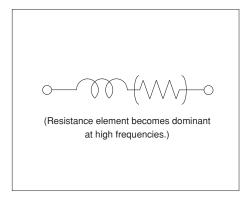
EMIFIL® (Inductor type) Chip Ferrite Bead

BLM03PX Series (0201 Size)

Dimensions



■ Equivalent Circuit



Packaging

Code	Packaging	Minimum Quantity	
D	180mm Paper Tape	15000	
J	330mm Paper Tape	50000	
В	Bulk(Bag)	1000	

■ Rated Value (□: packaging code)

Part Number	Impedance (at 100MHz/20°C)	Impedance (at 1GHz/20°C)	Rated Current	DC Resistance	Operating Temperature Range
BLM03PX220SN1□	22ohm ±25%	-	1800mA	0.040ohm max.	-55 to +125°C
BLM03PX330SN1□	33ohm ±25%	-	1500mA	0.055ohm max.	-55 to +125°C
BLM03PX800SN1□	80ohm ±25%	-	1000mA	0.130ohm max.	-55 to +125°C

Number of Circuits: 1

Continued on the following page.



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- 2. This datasheet has only typical specifications because there is no space for detailed specifications. Therefore, please approve our product specifications or transact the approval sheet for product specifications before ordering.

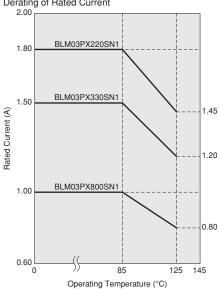


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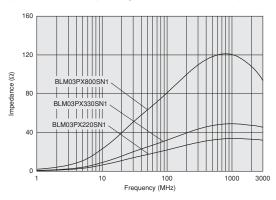
■ Derating of Rated Current

In operating temperature exceeding +85°C, derating of current is necessary for BLM03PX_SN1 series. Please apply the derating curve shown in chart according to the operating temperature.

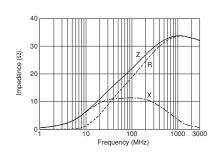
Derating of Rated Current



■ Impedance-Frequency Characteristics (Main Items)



■ Impedance-Frequency Characteristics BLM03PX220SN1



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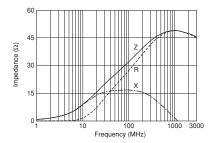
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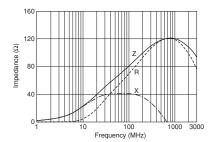
Data Sheet

Continued from the preceding page.

■ Impedance-Frequency Characteristics BLM03PX330SN1



■ Impedance-Frequency Characteristics BLM03PX800SN1



3

■ ①Caution/Notice

Do not use products beyond the rated current as this may create excessive heat and deteriorate the insulation resistance.

Notice

Solderability of Tin plating termination chip might be deteriorated when low temperature soldering profile where peak solder temperature is below the Tin melting point is used. Please confirm the solderability of Tin plating termination chip before use.

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